

DECLARATION FOR PATENT APPLICATION
English Language Declaration

As a below-named inventor, I hereby declare that:

My residence, mailing address, and citizenship are as stated below next to my name.

I believe that I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter that is claimed and for which a patent is sought on the invention entitled:

SYSTEM FOR FORMING COMPOSITE POLYMER DIELECTRIC FILM

the specification of which was filed on March 31, 2004 as U.S. Patent Application Serial No. 10/816,179.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information that is material to patentability as defined in 37 C.F.R. § 1.56, including, for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or (f) or 365(b) of any foreign application(s) for patent, inventor's or plant breeder's rights certificate(s), or 365(a) of any PCT international application that designated at least one country other than the United States of America, listed below, and also have identified below any foreign application for patent, inventor's or plant breeder's rights certificate(s), or any PCT international application having a filing date before that of the application on which priority is claimed.

Prior Foreign Application Number(s)	Country	Foreign Filing Date (MM/DD/YYYY)	Priority Claimed?	Certified Copy Attached?

DIRECT COMMUNICATIONS TO:

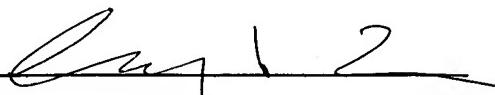
M. Matthews Hall
Kolisch Hartwell, P.C.
200 Pacific Building
520 S.W. Yamhill Street
Portland, Oregon 97204

Telephone: (503) 224-6655
Facsimile: (503) 295-6679
Email: hall@khpatent.com

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of sole or first joint inventor: CHUNG J. LEE

Inventor's signature:



Date: 3-30-2004

Residence: 43520 Homestead Court, Fremont, California 94538

Citizenship: United States of America

Post Office Address: 43520 Homestead Court, Fremont, California 94538

Full name of second joint inventor: ATUL KUMAR

Inventor's signature:



Date: 3/30/04

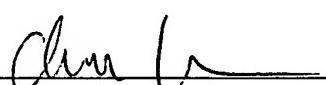
Residence: 1512 Vista Club Circle #202, Santa Clara, California 95054

Citizenship: India

Post Office Address: 1512 Vista Club Circle #202, Santa Clara, California 95054

Full name of third joint inventor: CHIEH CHEN

Inventor's signature:



Date: 3/30/2004

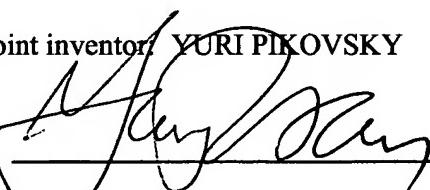
Residence: 4231 Wilkie Way, Palo Alto, California 94306

Citizenship: Taiwan, R.O.C.

Post Office Address: 4231 Wilkie Way, Palo Alto, California 94306

Full name of fourth joint inventor: YURI PIKOVSKY

Inventor's signature:



Date: 3/30/2004

Residence: 1031 Cynthia Lane, San Jose, California 95129

Citizenship: United States of America

Post Office Address: 1031 Cynthia Lane, San Jose, California 95129



**POWER OF ATTORNEY,
STATEMENT UNDER 37 C.F.R. § 3.73(b), and
ASSERTION OF RIGHT UNDER 37 C.F.R. § 3.71 AND MPEP § 106**

Applicants: Chung J. Lee, Atul Kumar, Chieh Chen and Yuri Pikovsky
 Serial No.: 10/816,179
 Filed: March 31, 2004
 Title: SYSTEM FOR FORMING COMPOSITE POLYMER DIELECTRIC FILM

Dielectric Systems, Inc., a California corporation, hereby appoints the practitioners at Kolisch Hartwell, P.C., USPTO Customer No. 23581, as its attorneys and agents to prosecute the above-identified patent application and to transact all business in the United States Patent and Trademark Office connected therewith. These practitioners currently include:

J. Pierre Kolisch, Reg. No. 15,802; John M. McCormack, Reg. No. 26,948; Peter E. Heuser, Reg. No. 27,902; David P. Cooper, Reg. No. 33,372; Pierre C. Van Rysselberghe, Reg. No. 33,557; Walter W. Karnstein, Reg. No. 35,565; Charles H. DeVoe, Reg. No. 37,305; David S. D'Ascenzo, Reg. No. 39,952; Owen W. Dukelow, Reg. No. 41,002; James R. Abney, Reg. No. 42,253; Mark D. Alleman, Reg. No. 42,257; M. Matthews Hall, Reg. No. 43,653; Christopher S. Tuttle, Reg. No. 41,357; B. Anna McCoy, Reg. No. 46,077; Ellen M. Gonzales, Reg. No. 44,128; Jason C. Creasman, Reg. No. 51,587; Edward B. Anderson, Reg. No. 30,154; Peter D. Sabido, Reg. No. 50,353; John D. Russell, Reg. No. 47,048; Douglas W. McArthur, Reg. No. 50,795; Stanley M. Hollenberg, Reg. No. 47,658; and Anton E. Skaugset, Reg. No. 38,617.

Dielectric Systems, Inc. states, under 37 C.F.R. § 3.73(b), that it is the assignee of the entire right, title, and interest in the above-identified patent application by virtue of an assignment from each of the inventor(s) named in the above-identified patent application. Copies of assignments or other documents in the chain of title are attached.

Dielectric Systems, Inc. hereby asserts its right, under 37 C.F.R. § 3.71 and MPEP § 106, to conduct the prosecution of the above-identified patent application to the exclusion of the named inventor(s) and any previous assignee(s).

DIRECT COMMUNICATIONS TO:

M. Matthews Hall
 Kolisch Hartwell, P.C.
 200 Pacific Building
 520 S.W. Yamhill Street
 Portland, Oregon 97204

Telephone: (503) 224-6655
 Facsimile: (503) 295-6679
 E-Mail: hall@khpatent.com

The undersigned (whose title is supplied below) is authorized to act on behalf of the above-identified assignee.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements are made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

DIELECTRIC SYSTEMS, INC.

Date: 30 - 30 - 2004


 Name: CHUNG J. Lee

Title: President

COPY

ASSIGNMENT

WHEREAS, we, Chung J. Lee of Fremont, California, Atul Kumar of Santa Clara, California, Chieh Chen of Palo Alto, California, and Yuri Pikovsky of San Jose, California, have invented certain improvements in a SYSTEM FOR FORMING COMPOSITE POLYMER DIELECTRIC FILM, for which we filed U.S. patent application Serial No. 10/816,179 on March 31, 2004; and

WHEREAS, Dielectric Systems, Inc., a California corporation, having its principal place of business in Fremont, California, is desirous of acquiring an interest therein;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which hereby are acknowledged, we, Chung J. Lee, Atul Kumar, Chieh Chen and Yuri Pikovsky have sold, assigned, and transferred, and do hereby sell, assign, and transfer, to Dielectric Systems, Inc., its successors and assigns, the full and exclusive right to the invention in the United States and its territorial possessions and in all foreign countries, and the entire right, title, and interest in and to any and all Letters Patent that may be granted therefor in the United States and its territorial possessions and in any and all foreign countries, and in and to any and all divisions, continuations, reissues, substitutions, and extensions thereof.

We hereby authorize and request the Patent Office officials in the United States and any and all foreign countries to issue any and all of said Letters Patent, when granted, to Dielectric Systems, Inc., as the assignee of our entire right, title, and interest in and to the same, for the sole use of Dielectric Systems, Inc., and its successors and assigns.

Further, we hereby covenant and agree to and with Dielectric Systems, Inc., and its successors and assigns, at the time of execution and delivery of these presents, that we are

are the sole and lawful owner of the entire right, title, and interest in and to the invention and the above-identified patent application, and that the same are unencumbered, and that we have good and full right and lawful authority to sell and convey the same in the manner herein set forth.

Further, we agree that we will communicate to Dielectric Systems, Inc., or its representatives, any facts known to us respecting the invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue, substitution, and extension applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to Dielectric Systems, Inc., make all rightful oaths, and generally do everything possible to aid Dielectric Systems, Inc., and its successors and assigns, to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, I have hereunto set my hand this _____
day of April 28, 2004.


CHUNG J. LEE

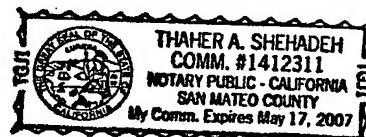
Witness:

Signature: _____ SUBSCRIBED AND SWORN TO BEFORE ME
THIS 28th DAY OF April, 2004

Name: _____ By Chung J. Lee

Address: _____

City & State: _____
Thaher A. Shehadeh
Notary Public in and for the State of California, County of Alameda



IN TESTIMONY WHEREOF, I have hereunto set my hand this 28 day of
APRIL, 2004.

Atul Kumar
ATUL KUMAR

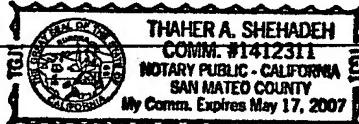
Witness:

SUBSCRIBED AND SWORN TO BEFORE ME

Signature: _____

THIS 28th DAY OF April, 18 2004

Name: _____



By Atul Kumar

Address: _____

Thafer A. Shehadeh

City & State: _____

Notary Public in and for the State of
California, County of Alameda

IN TESTIMONY WHEREOF, I have hereunto set my hand this 28 day of
April, 2004.

Chieh Chen
CHIEH CHEN

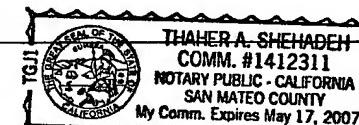
Witness:

SUBSCRIBED AND SWORN TO BEFORE ME

Signature: _____

THIS 28th DAY OF April, 18 2004

Name: _____



Address: _____

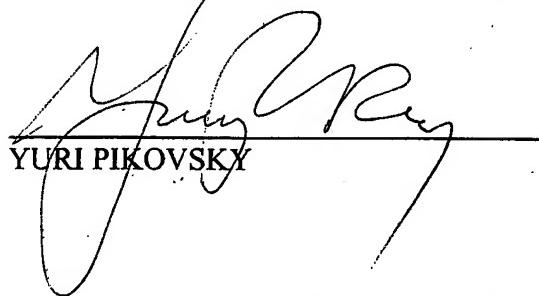
Chieh Chen

City & State: _____

Notary Public in and for the State of
California, County of Alameda

IN TESTIMONY WHEREOF, I have hereunto set my hand this 28 day of

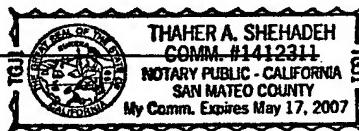
April, 2004.


YURI PIKOVSKY

Witness:

Signature: _____

Name: _____



Address: _____

City & State: _____

SUBSCRIBED AND SWORN TO BEFORE ME

THIS 28th DAY OF April, 2004,

By Yuri Pikovsky _____

D. Prochazka

Thaher A. Shehadeh
Notary Public in and for the State of
California, County of Alameda